

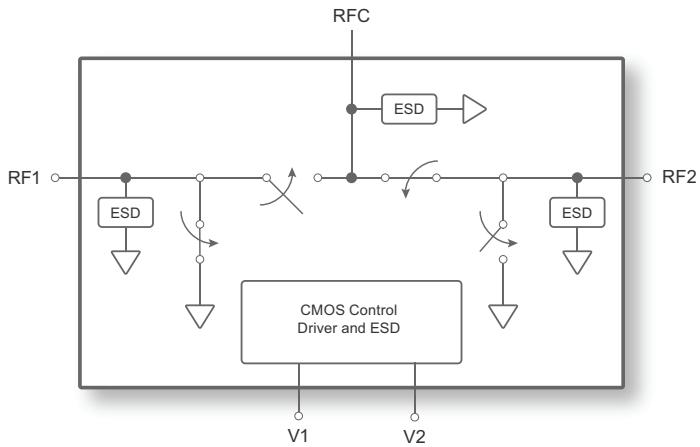
Features

- AEC-Q100 Grade 2-qualified
- Broadband frequency support: 0.3 to 10.6 GHz
- Suitable for ISM band, Bluetooth®, 802.11 a/b/g/n/ac/ax and ultra-wideband (UWB)
- Low power consumption of 90 nA
- Low insertion loss
 - 0.4 dB @ 6 GHz
 - 0.6 dB @ 8.5 GHz
 - 0.7 dB @ 10.6 GHz
- High isolation
 - 27 dB @ 6 GHz
 - 18 dB @ 8.5 GHz
 - 18 dB @ 10.6 GHz
- P1dB = +24 dBm
- Switching time = 100 ns
- Operating temperature range: -40 to +105 °C
- ESD performance
 - 2000V HBM
 - 500V CDM
- Packaging – 6-lead 1.6 × 1.6 mm DFN

Applications

- 802.11 a/b/g/n/ac/ax and Bluetooth
- Ultra-wideband (UWB)
- Remote keyless entry
- Telematics
- Infotainment
- In-cabin monitoring system (ICMS)
- General-purpose switching

Figure 1 • PE423211 Functional Diagram



Product Description

The PE423211 is a HaRP™ technology-enhanced reflective SPDT RF switch designed for use in high-performance ISM, WLAN 802.11 a/b/g/n/ac/ax, Bluetooth and UWB applications supporting bandwidths up to 10.6 GHz.

This switch features low power consumption, low insertion loss, high port-to-port isolation, fast switching speed, and high-power handling, all in a compact 6-lead 1.6 × 1.6 mm DFN package. The PE423211 device also has robust ESD and temperature performance.

The PE423211 is manufactured on pSemi's UltraCMOS® process, a patented silicon-on-insulator (SOI) technology.

Absolute Maximum Ratings

Exceeding absolute maximum ratings listed in **Table 1** may cause permanent damage. Operation should be restricted to the limits in **Table 2**. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

ESD Precautions

When handling this UltraCMOS device, observe the same precautions as with any other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in **Table 1**.

Latch-up Immunity

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

Table 1 • Absolute Maximum Ratings for PE423211

Parameter/Condition	Symbol	Min	Max	Unit
Digital input (V1)	V1	-0.3	3.6	V
Digital input (V2)	V2	-0.3	3.6	V
RF input power, 300-6000 MHz	P _{MAX,ABS}		25	dBm
RF input power, 8500-10600 MHz	P _{MAX,ABS}		25	dBm
Storage temperature range	T _{ST}	-65	150	°C
ESD voltage HBM, all pins ⁽¹⁾	V _{ESD,HBM}		2000	V
ESD voltage CDM, all pins ⁽²⁾	V _{ESD,MM}		500	V

Notes:

- 1) Human body model (MIL-STD 883 Method 3015).
- 2) Charged device model (JEDEC JESD22-C101).

Switching Capability

Switching time is the time duration between the point the control signal reaches 50% of the final value and the point the output signal reaches within 10% or 90% of its target value.

Recommended Operating Conditions

Table 2 lists the recommended operating conditions for the PE423211. Devices should not be operated outside the operating conditions listed below.

Table 2 ■ Recommended Operating Conditions for PE423211

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage		2.7	3.3	3.6	V
Supply current			90	300	nA
Digital input high (V1/V2)	V_{IH}	2.7		3.6	V
Digital input low (V1/V2)	V_{IL}	-0.3		0.6	V
RF input power, CW, 300–10600 MHz	$P_{MAX,CW}$			22	dBm
Operating temperature range	T_{OP}	-40	25	105	°C

Control Logic Truth Table

Table 3 provides the control logic truth table for the PE423211.

Table 3 ■ Truth Table for the PE423211

V1	V2	ON Path
0	1	RFC-RF1
1	0	RFC-RF2

Electrical Specifications

Table 4 provides the PE423211 key electrical specifications @ 25°C, V1 = 0V, V2 = 3.3V, ($Z_L = Z_S = 50\Omega$), unless otherwise specified.

Table 4 • PE423211 Electrical Specifications

Parameter	Symbol	Path	Condition	Min	Typ	Max	Unit
Operating frequency				0.3		10.6	GHz
Insertion loss	IL	RFC-RFX	0.3 – 6.0 GHz 6.0 – 8.5 GHz 8.5 – 10.6 GHz		0.4 0.6 0.7	0.6 0.8 0.9	dB dB dB
Isolation	ISO	RFC-RFX	0.3 – 6.0 GHz 6.0 – 8.5 GHz 8.5 – 10.6 GHz	25 17 16	27 18 18		dB dB dB
Return loss (common and active port)	RL	RFC-RFX	0.3 – 6.0 GHz 6.0 – 8.5 GHz 8.5 – 10.6 GHz	13 12 11	22 21 19		dB dB dB
Input 1dB compression point	P1dB	RFC-RFX	0.3 – 10.6 GHz		24		dBm
2nd harmonic	2fo	RFC-RFX	fo = 399 MHz		-60.0	-58.0	dBm
3rd harmonic	3fo	RFC-RFX	fo = 399 MHz		-76.0	-70.0	dBm
Switching time		T _{SW}	50% CTRL to 90% or 10% of final value		100	200	ns

Typical Performance Data

Figure 2–Figure 18 show the typical performance data at @ 25°C, V1 = 0V, V2 = 3.3V, (ZL = ZS = 50Ω), unless otherwise specified.

Figure 2 • Insertion Loss vs. Switch Path

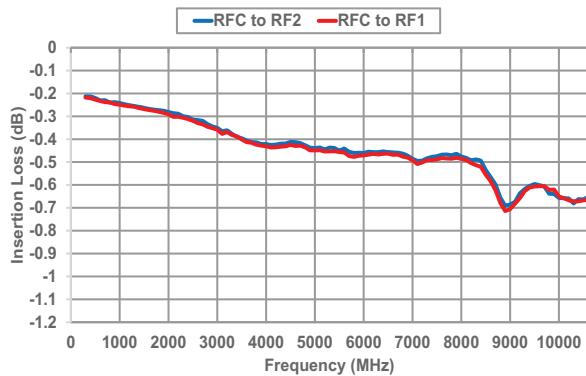


Figure 3 • Insertion Loss vs. Temperature

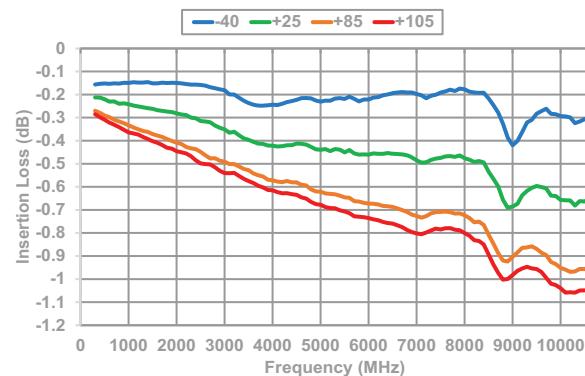


Figure 4 • Insertion Loss vs. Voltage

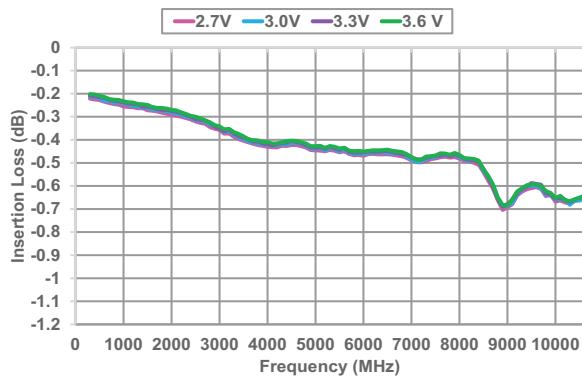


Figure 5 • Isolation vs. Temperature (RFC-RFX)

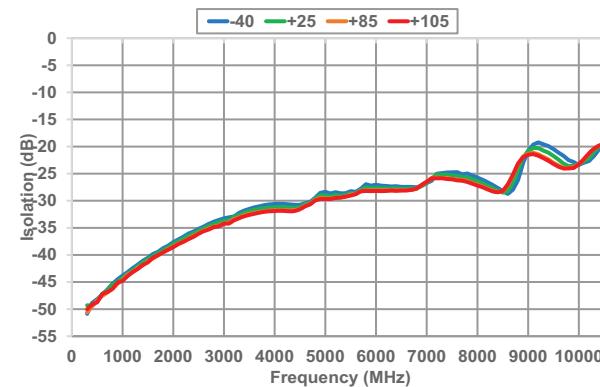


Figure 6 • Isolation vs. Voltage (RFC-RFX)

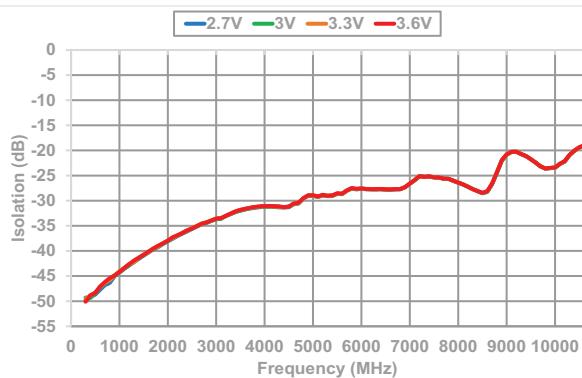


Figure 7 • Isolation vs. Temperature (RFX-RFX)

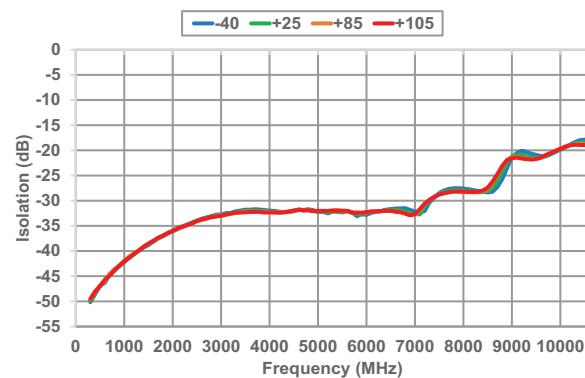


Figure 8 • Isolation vs. Voltage (RFX-RFX)

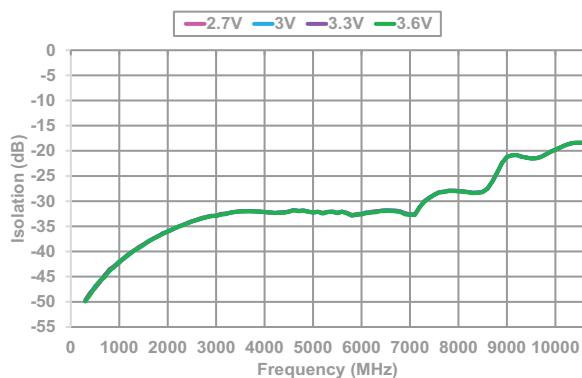


Figure 9 • RFC Port Return Loss vs. Temperature (RF1 Active)

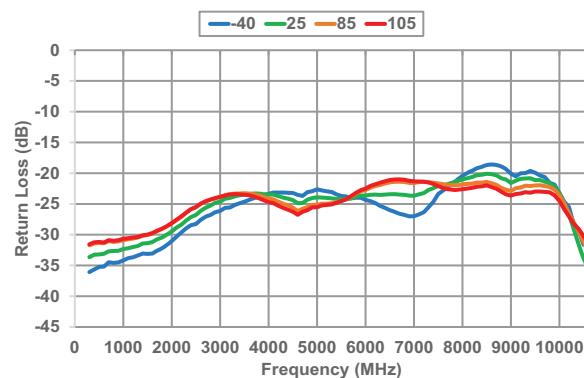


Figure 10 • RFC Port Return Loss vs. Voltage (RF1 Active)

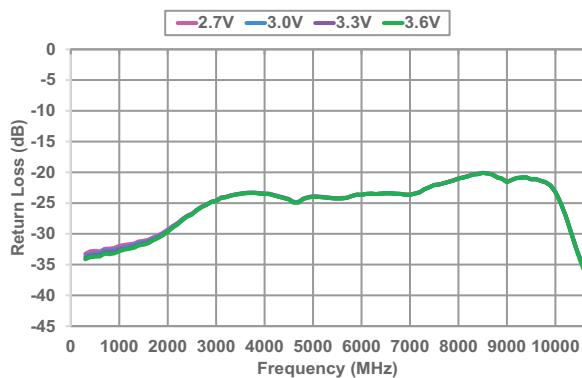


Figure 11 • RFC Port Return Loss vs. Temperature (RF2 Active)

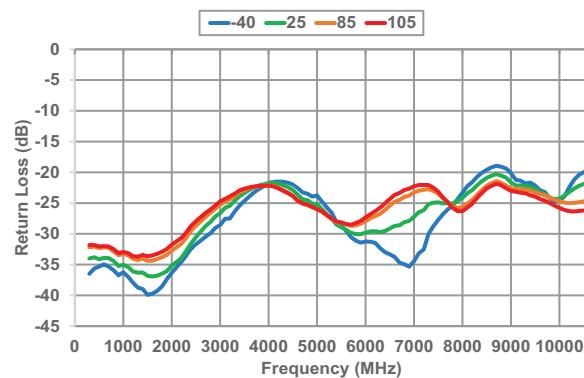


Figure 12 • RFC Port Return Loss vs. Voltage (RF2 Active)

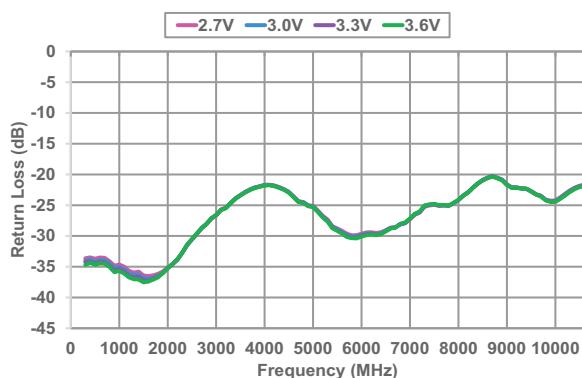


Figure 13 • RF1 Port Return Loss vs. Temperature (RF1 Active)

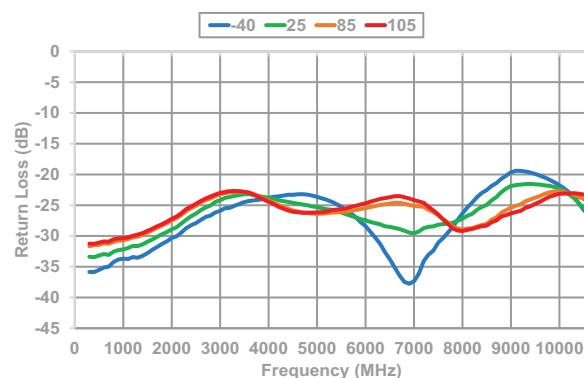


Figure 14 • RF1 Port Return Loss vs. Voltage (RF1 Active)

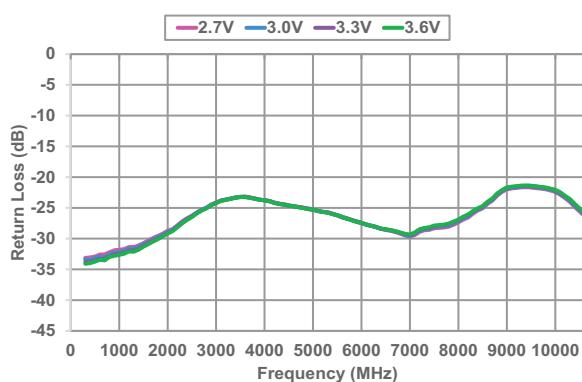


Figure 15 • RF2 Port Return Loss vs. Temperature (RF2 Active)

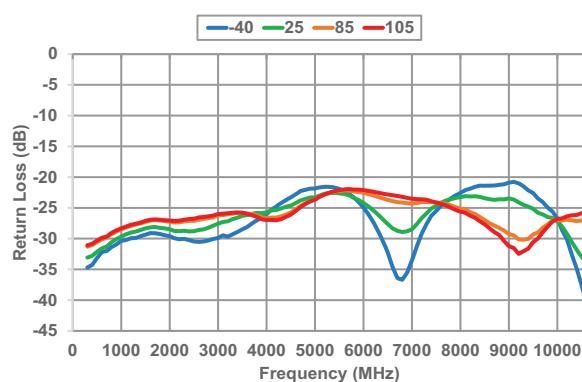


Figure 16 • RF2 Port Return Loss vs. Voltage (RF2 Active)

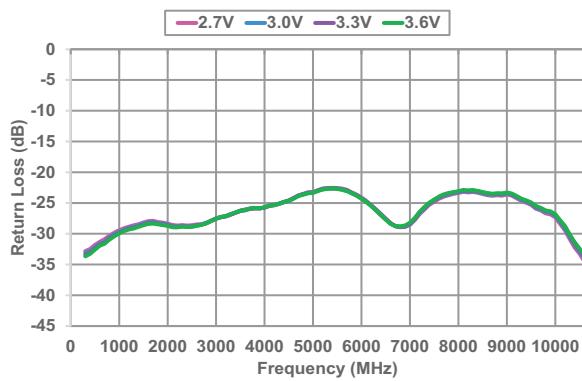


Figure 17 • Maximum Power Handling ($V_{DD} = 3.3V$)

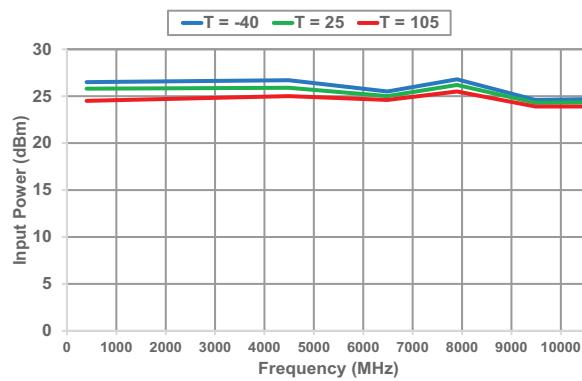
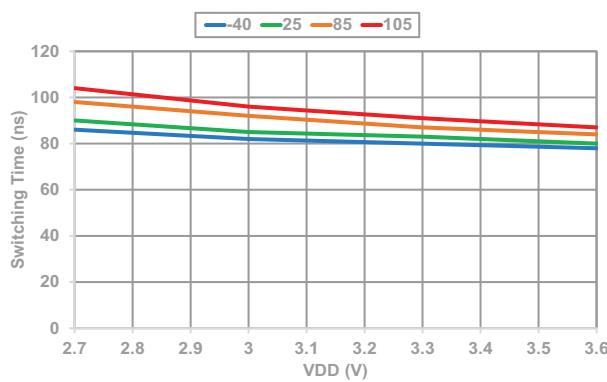


Figure 18 • Switching Time vs. V_{DD}



Pin Information

This section provides pinout information for the PE423211. **Figure 19** shows the pin map of this device for the available package. **Table 5** provides a description for each pin.

Figure 19 • Pin Configuration (Top View)

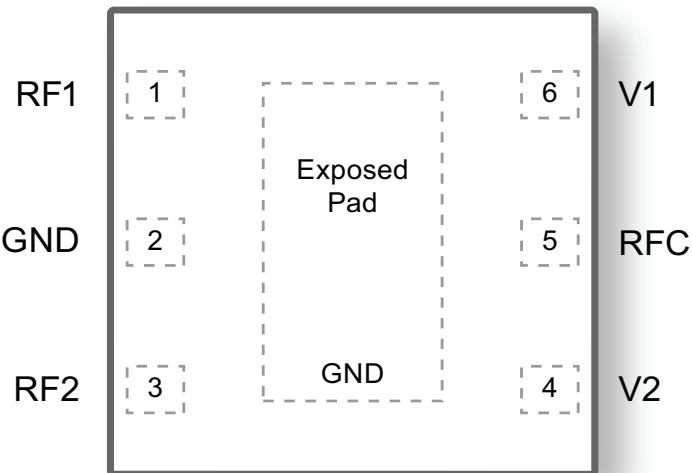


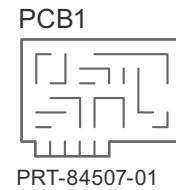
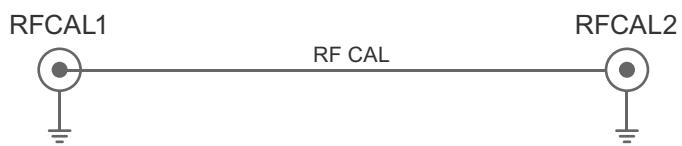
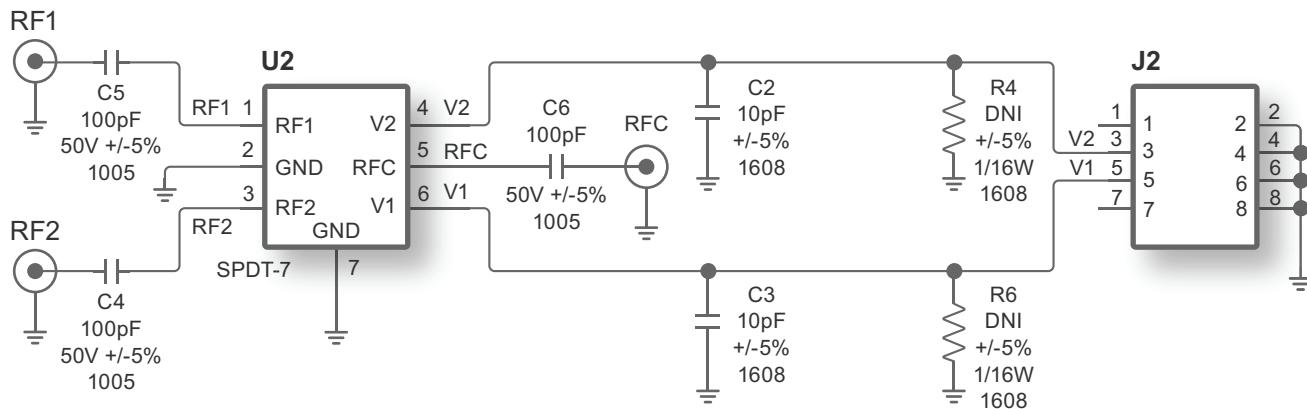
Table 5 • Pin Descriptions for PE423211

Pin No.	Pin Name	Description
1	RF1	RF port 1
2	GND	Ground
3	RF2	RF port 2
4	V2	Digital control logic input 2
5	RFC	RF common port
6	V1	Digital control logic input 1
Pad	GND	Ground

Application Schematic

The application schematic for the PE423211 is shown in **Figure 20**.

Figure 20 • Application Schematic for the PE423211



Packaging Information

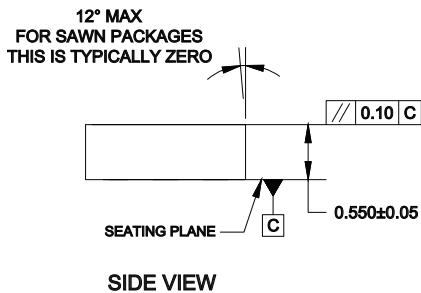
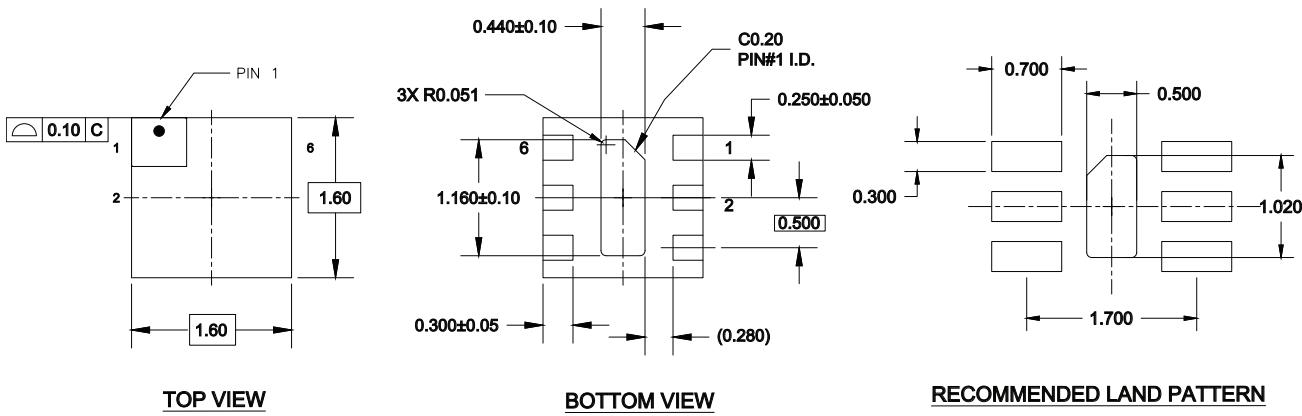
This section provides packaging data including the moisture sensitivity level, package drawing, package marking and tape-and-reel information.

Moisture Sensitivity Level

The moisture sensitivity level rating for the PE423211 in the 6-lead 1.6 × 1.6 mm DFN package is MSL 1.

Package Drawing

Figure 21 • Package Mechanical Drawing for 6-lead 1.6 × 1.6 mm DFN



Third Angle Projection

Unless otherwise specified
dimensions are in millimeters
Refer to comment for
overall tolerance

Top-Marking Specification

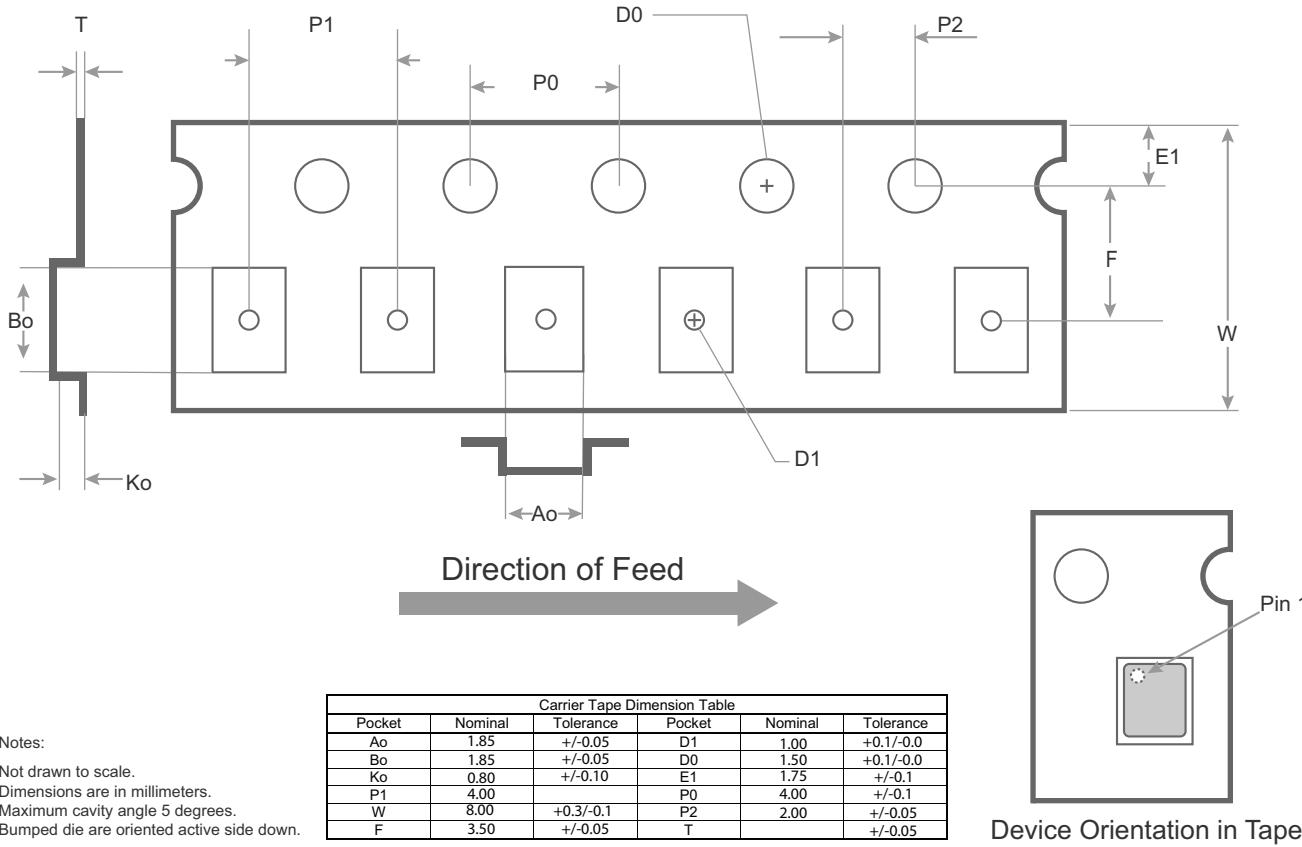
Figure 22 • Package Marking Specifications for PE423211



- = Pin 1 indicator
- P = Part number code*
- ZZ = Last two characters of the assembly lot code
- Y = Last digit of year, starting from 2010
- WW = Work week

Tape and Reel Specification

Figure 23 • Tape and Reel Specifications for 6-lead 1.6 × 1.6 mm DFN



Ordering Information

Table 6 lists the available ordering codes for the PE423211 as well as available shipping methods.

Table 6 • Order Codes for PE423211

Order Codes	Description	Packaging	Shipping Method
PE423211A-Z	PE423211 SPDT RF switch	Green 6-lead 1.6 × 1.6 mm DFN	3000 units/T&R
EK423211-01	PE423211 Evaluation kit	Evaluation kit	1/Box

Document Categories

Advance Information

The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

Preliminary Specification

The datasheet contains preliminary data. Additional data may be added at a later date. pSemi reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

The datasheet contains final data. In the event pSemi decides to change the specifications, pSemi will notify customers of the intended changes by issuing a CNF (Customer Notification Form).

Product Brief

This document contains a shortened version of the datasheet. For the full datasheet, contact sales@psemi.com.

Sales Contact

For additional information, contact Sales at sales@psemi.com.

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